

## Small Signal Schottky Diode



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### MECHANICAL DATA

**Case:** MiniMELF (SOD-80)

**Weight:** approx. 31 mg

**Cathode band color:** black

**Packaging codes/options:**

GS18/10K per 13" reel (8 mm tape), 10K/box

GS08/2.5K per 7" reel (8 mm tape), 12.5K/box

### FEATURES

- For general purpose applications
- This diode features low turn-on voltage
- The devices are protected by a PN junction guard ring against excessive voltage, such as electrostatic discharges
- This diode is also available in a DO-35 case with type designation BAT85
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT

### APPLICATIONS

- Applications where a very low forward voltage is required

### PARTS TABLE

PART	ORDERING CODE	CIRCUIT CONFIGURATION	REMARKS
BAS85	BAS85-GS18 or BAS85-GS08	Single	Tape and reel

### ABSOLUTE MAXIMUM RATINGS ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Continuous reverse voltage		$V_R$	30	V
Forward continuous current <sup>(1)</sup>		$I_F$	200	mA
Peak forward current <sup>(1)</sup>		$I_{FM}$	300	mA
Surge forward current <sup>(1)</sup>	$t_p < 1\text{ s}$	$I_{FSM}$	600	mA
Power dissipation <sup>(1)</sup>	$T_{amb} = 65\text{ }^{\circ}\text{C}$	$P_{tot}$	200	mW

**Note**

<sup>(1)</sup> Valid provided that electrodes are kept at ambient temperature

### THERMAL CHARACTERISTICS ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Thermal resistance junction to ambient air <sup>(1)</sup>		$R_{thJA}$	430	K/W
Junction temperature		$T_j$	125	$^{\circ}\text{C}$
Storage temperature range		$T_{stg}$	-55 to +150	$^{\circ}\text{C}$

**Note**

<sup>(1)</sup> Valid provided that electrodes are kept at ambient temperature

<b>ELECTRICAL CHARACTERISTICS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Reverse breakdown voltage	$I_R = 10\text{ }\mu\text{A}$ (pulsed)	$V_{(BR)}$	30			V
Leakage current	$V_R = 25\text{ V}$	$I_R$		0.2	2	$\mu\text{A}$
Forward voltage	Pulse test $t_p < 300\text{ }\mu\text{s}$ , $I_F = 0.1\text{ mA}$	$V_F$			240	mV
	Pulse test $t_p < 300\text{ }\mu\text{s}$ , $I_F = 1\text{ mA}$	$V_F$			320	mV
	Pulse test $t_p < 300\text{ }\mu\text{s}$ , $I_F = 10\text{ mA}$	$V_F$			400	mV
	Pulse test $t_p < 300\text{ }\mu\text{s}$ , $I_F = 30\text{ mA}$	$V_F$		500		mV
	Pulse test $t_p < 300\text{ }\mu\text{s}$ , $I_F = 100\text{ mA}$	$V_F$			800	mV
Diode capacitance	$V_R = 1\text{ V}$ , $f = 1\text{ MHz}$	$C_D$			10	pF
Reverse recovery time	$I_F = 10\text{ mA}$ , $I_R = 10\text{ mA}$ , $I_R = 1\text{ mA}$	$t_{rr}$			5	ns

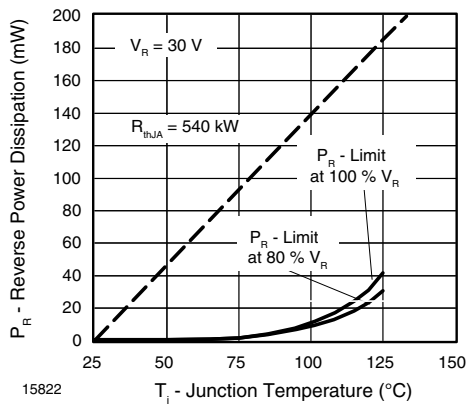
**TYPICAL CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)


Fig. 1 - Max. Reverse Power Dissipation vs. Junction Temperature

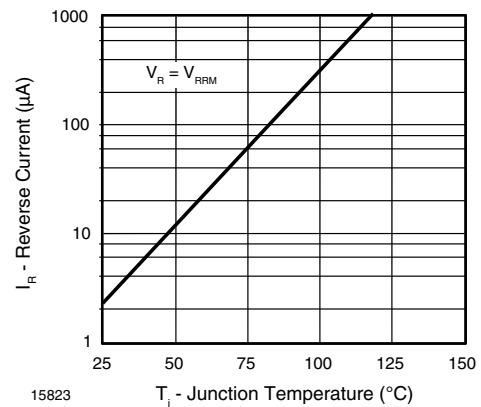


Fig. 3 - Reverse Current vs. Junction Temperature

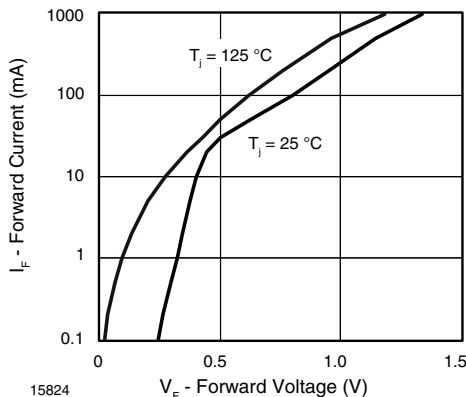


Fig. 2 - Forward Current vs. Forward Voltage

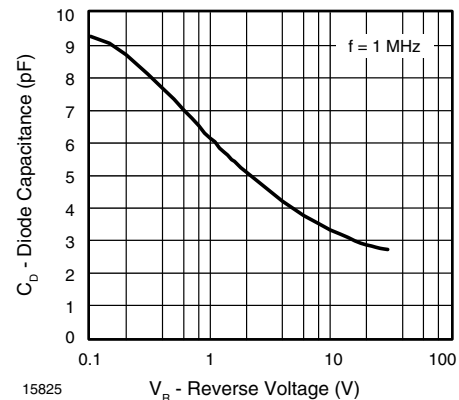
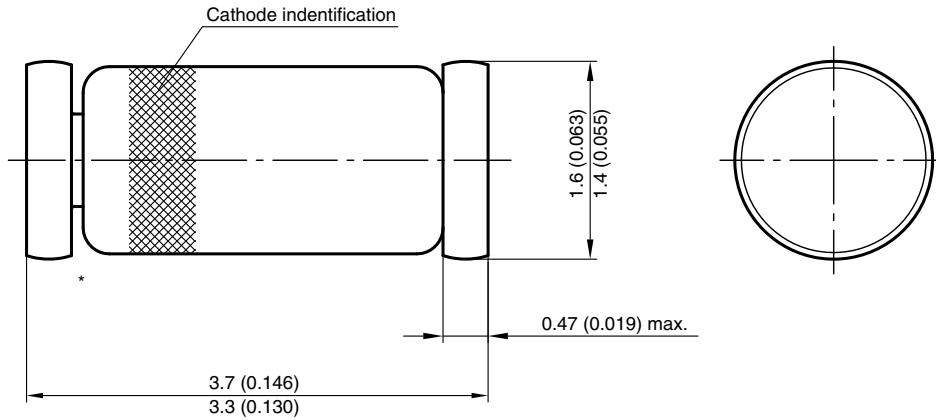


Fig. 4 - Diode Capacitance vs. Reverse Voltage

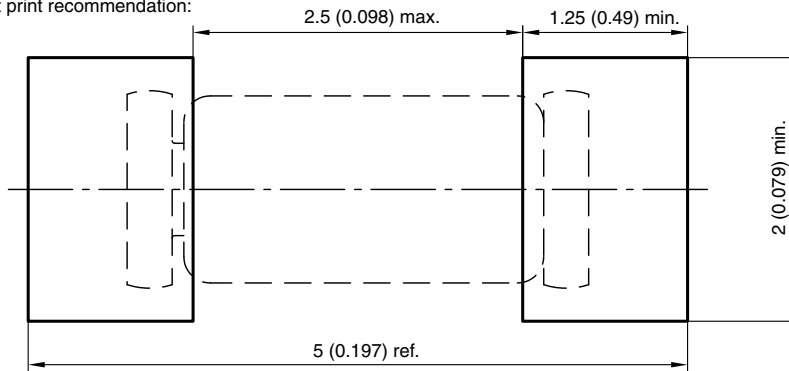


**PACKAGE DIMENSIONS** in millimeters (inches): **MiniMELF (SOD-80)**



\* The gap between plug and glass can be either on cathode or anode side

Foot print recommendation:



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